### Overview

#### HP ProBook x360 435 G8 Notebook PC



- 1. Internal Microphones
- 2. Webcam LED
- 3. Webcam and IR Camera (Optional)
- 4. HP Privacy Camera
- 5. IR Camera LED (Optional)
- 6. Clickpad

#### Left

- 7. World-facing Camera (Optional)
- 8. World-facing Camera LED (Optional)
- 9. Vents
- 10. SuperSpeed USB Type-A 5 Gbps signaling rate charging Port
- 11. Nano Security Lock Slot (Lock Sold Separately)

### **Overview**



- 1. Power Button
- 2. Power Connector
- 3. SuperSpeed USB Type-C<sup>®</sup> 10Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4)
- 4. SuperSpeed USB Type-A 5 Gbps signaling rate Port

#### Right

- 5. HDMI 1.4b Port (Cable not included)
- 6. Audio Combo Jack
- 7. MicroSD Card reader
- 8. Touch Fingerprint Sensor (Select models)

#### Overview

#### AT A GLANCE

- Preinstalled with Windows 10 versions or FreeDOS
- A stylish and professional convertible adapts with versatile use modes from traditional laptop to tablet, stand and tent that enables to create, present and collaborate
- Sleek and durable anodized aluminum top cover and keyboard deck
- Choice of AMD Ryzen™ 5000 series mobile processors
- Integrated AMD Radeon™ Graphics
- Display include your choice of 33.8 cm (13.3") diagonal IPS Wide Viewing Angle, FHD, touch screen with Corning® Gorilla® Glass 5
- Commercial-grade security features including HP Sure Start, HP Sure Sense, HP Client Security, HP Sure Click, HP Privacy Camera and optional HP Sure View
- Captures the world around with an optional world facing- camera in the keyboard<sup>1</sup>
- Supports wireless LAN options for connectivity on the go including gigabit data rate Wi-Fi® 61
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles
- Undergoes MIL-STD 810H tests<sup>2</sup>

#### 1. Sold separately or as an optional feature.

2. MIL STD 810H testing is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or formilitary use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



### **Technical Specifications**

#### **PRODUCT NAME**

HP ProBook x360 435 G8 Notebook PC

#### **OPERATING SYSTEM**

Preinstalled Windows 10 Pro 64 – HP recommends Windows 10 Pro 1

Windows10 Pro 64 (National Academic License)<sup>2</sup>

Windows10 Home 641

Windows10 Home Single Language 641

Windows 10 Pro (Windows 10 Enterprise available with a Volume Licensing Agreement)<sup>1</sup>

Windows10 Enterprise 64 (Web Support)1

**FreeDOS** 

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <a href="http://www.windows.com/">http://www.windows.com/</a>.

2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

Note: HP tested Windows 10, version 1909 on this platform. For testing information on newer versions of Windows 10, please see https://support.hp.com/document/c05195282.

#### **PROCESSORS**

AMD Ryzen<sup>™</sup> 3 5400U (up to 4.0 GHz max boost clock, 10 MB L3 cache, 4 cores) <sup>3,4,5,6</sup>
AMD Ryzen<sup>™</sup> 5 5600U with Radeon<sup>™</sup> Graphics (2.3 GHz base clock, up to 4.2 GHz max boost clock, 16 MB L3 cache, 6 cores) <sup>3,4,5,6</sup>
AMD Ryzen<sup>™</sup> 7 5800U with Radeon<sup>™</sup> Graphics (1.9 GHz base clock, up to 4.4 GHz max boost clock, 16 MB L3 cache, 8 cores) <sup>3,4,5,6</sup>

#### **Processor Family**

AMD Ryzen<sup>™</sup> 3 processor<sup>6</sup> AMD Ryzen<sup>™</sup> 5 processor<sup>6</sup> AMD Ryzen<sup>™</sup> 7 processor<sup>6</sup>

- 3. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
- 4. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering is not a measurement of clock speed.
- 5. AMD Max Burst frequency performance varies depending on hardware, software and overall system configuration.
- 6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on <a href="http://www.support.hp.com">http://www.support.hp.com</a>.

#### **CHIPSET**

Chipset is integrated with processor.



### **Technical Specifications**

#### **GRAPHICS**

#### Integrated

AMD Radeon™ Graphics

#### **Supports**

Support HD decode, DX12, HDMI1.4b7, via HDMI up to 4K 30Hz

7. HDMI cable sold separately.

#### **DISPLAY**

#### **Touch**

33.8 cm (13.3") diagonal FHD UWVA eDP BrightView WLED-backlit touch screen with Corning® Gorilla® Glass 5, 250 nits, 45% NTSC with HD camera (1920 x 1080) 8,9,10

33.8 cm (13.3") diagonal FHD UWVA eDP BrightView WLED-backlit touch screen with Corning® Gorilla® Glass 5, 250 nits, 45% NTSC with HD + IR camera (1920 x 1080) 8,9,10

33.8 cm (13.3") diagonal FHD UWVA eDP + PSR BrightView WLED-backlit touch screen with Corning® Gorilla® Glass 5, Low Power, 400 nits, 72% NTSC with HD camera (1920 x 1080) 8,9,10

33.8 cm (13.3") diagonal FHD UWVA eDP + PSR BrightView WLED-backlit touch screen with Corning® Gorilla® Glass 5, Low Power, 400 nits, 72% NTSC with HD + IR camera (1920 x 1080) 8.9,10

HP Sure View Integrated Privacy Screen 33.8 cm (13.3") diagonal FHD UWVA eDP + PSR BrightView WLED-backlit touch screen with Corning® Gorilla® Glass 5, 1000 nits, 72% NTSC with HD camera (1920 x 1080) 8,9,10,11

HP Sure View Integrated Privacy Screen 33.8 cm (13.3") diagonal FHD UWVA eDP + PSR BrightView WLED-backlit touch screen with Corning® Gorilla® Glass 5, 1000 nits, 72% NTSC with HD + IR camera (1920 x 1080) 8,910,11

- 8. FHD/HD content required to view FHD/HD images.
- 9. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
- 10. Actual brightness will be lower with touchscreen or Sure View.
- 11. HP Sure View integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.



### **Technical Specifications**

#### STORAGE AND DRIVES

#### **Primary M.2 Storage**

128 GB PCIe® Gen3x4 NVMe™ TLC Solid State Drive 12 256 GB PCIe® NVMe™ Value Solid State Drive 12 512 GB PCIe® NVMe™ Value Solid State Drive 12 512 GB PCIe® Gen3x4 NVMe™ TLC Solid State Drive 12 1 TB PCIe® Gen3x4 NVMe™ TLC Solid State Drive 12

12. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

#### **MEMORY**

#### **Maximum Memory**

32 GB DDR4-3200 SDRAM 13

#### Memory

32 GB DDR4 -3200 SDRAM (2 x 16GB) <sup>13</sup>
16 GB DDR4-3200 SDRAM (1 x 16 GB) <sup>13</sup>
16 GB DDR4-3200 SDRAM (2 x 8 GB) <sup>13</sup>
8 GB DDR4-3200 SDRAM (1 x 8 GB) <sup>13</sup>
8 GB DDR4-3200 SDRAM (2 x 4 GB) <sup>13</sup>
4 GB DDR4-3200 SDRAM (1 x 4 GB) <sup>13</sup>

#### **Memory Slots**

2 SODIMM
Both slots are customer accessible / upgradeable by IT or self-maintainers only.
DDR4 PC4 SODIMMS, system runs at 3200
Supports Dual Channel Memory

13. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

#### **NETWORKING/COMMUNICATIONS**

#### WLAN

Realtek RTL8822CE 802.11ac (2x2) and Bluetooth® 5 Combo <sup>14</sup> Intel® Dual Band Wireless-AC 9260 802.11a/b/g/n/ac (2x2) Wi-Fi ®and Bluetooth® 5 Combo, non-vPro® <sup>14</sup> Intel® AX200 Wi-Fi 6 (2x2) and Bluetooth® 5 Combo, non-vPro® <sup>15</sup>

#### Miracast

Native Miracast Support 16

14. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.

15. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax WLAN devices. Only available in countries where 802.11ax is supported.

16. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.



### **Technical Specifications**

#### **AUDIO/MULTIMEDIA**

#### Audio

Integrated microphone (Dual Array)
2 Integrated stereo speakers

#### **Speaker Power**

2W/4ohm Per speaker

#### Camera

User-facing 720p HD camera <sup>17,18</sup> User-facing 720p HD + IR camera <sup>17,18</sup> World-facing 5MP auto-focus secondary camera <sup>18</sup>

#### Sensors

Combo Chip (Accelerometer + Gyro) Magnetometer Hall Sensor

17. FHD/HD content required to view FHD/HD images.

18. Sold separately or as an optional feature.

#### **KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS**

#### Keyboard

HP Premium Keyboard, spill resistant with DuraKeys and optional backlit 19

#### **Pointing Device**

Clickpad with multi-touch gesture support

#### **Function Keys**

F1 - Display Switching

F2 - Blank or Privacy (with LED)

F3 - Brightness Down

F4 - Brightness Up

F5 - Audio Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Blank or Keyboard Backlit Toggle

F10 - Insert

F11 - Airplane Mode

F12 - HP Programmable Key

**Power Button** 

#### **Hidden Function Keys**

Fn+R - Break

Fn+S - Sys Rq

Fn+C - Scroll Lock

19. Backlit keyboard is an optional feature.

### **Technical Specifications**

#### **SOFTWARE AND SECURITY**

## Preinstalled Software BIOS

HP BIOSphere Gen6<sup>20</sup>

**BIOS Update via Network** 

HP Secure Erase<sup>21</sup>

Absolute Persistence Module<sup>22</sup>

HP Wake on WLAN

#### Software

HP Connection Optimizer23

**HP Hotkey Support** 

HP Support Assistant<sup>24</sup>

**HP Noise Cancellation Software** 

Buy Office (Sold separately)

Microsoft Defender<sup>25</sup>

#### **Manageability Features**

HP Driver Packs (download)26

**HP Client Catalog (download)** 

HP Manageability Integration Kit Gen4(download)<sup>27</sup>

**HP Image Assistant (download)** 

#### **Security Management**

TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified)

USB enable/disable (via BIOS)

Setup password (via BIOS)

Support for chassis padlocks and cable lock devices

HP Sure Click<sup>28</sup>

HP Sure Sense<sup>29</sup>

HP Sure Start Gen6 30

HP Sure View Gen331

HP Sure Admin<sup>32</sup>

HP Pro Security Edition (Select models)33

HP Fingerprint Sensor (Select models) 34

20. HP BIOSphere Gen6 is available on select HP Pro and Elite PCs. Features may vary depending on the platform and configurations.

21. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.

22. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is



### **Technical Specifications**

limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: https://www.absolute.com/about/legal/agreements/absolute/

- 23. HP Connection Optimizer requires Windows 10.
- 24. HP Support Assistant requires Windows and Internet access.
- 25. Windows Defender Opt in and internet connection required for updates.
- 26. HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.
- 27. HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html.
- 28. HP Sure Click requires Windows 10 Pro or Enterprise. See https://bit.ly/2PrLT6A\_SureClick for complete details.
- 29.HP Sure Sense is available on select HP PCs and is not available with Windows10 Home.
- 30. HP Sure Start Gen6 is available on select HP PCs and requires Windows 10.
- 31. HP Sure View Gen3 integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.
- 32. HP Sure Admin requires Windows 10, HP BIOS, HP Manageability Integration Kit from <a href="http://www.hp.com/go/clientmanagement">http://www.hp.com/go/clientmanagement</a> and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.
- 33. HP Pro Security Edition is available preloaded on select HP PCs and includes HP Sure Click Pro and HP Sure Sense Pro. 3-year license required. The HP Pro Security Edition software is licensed under the license terms of the HP End User License Agreement (EULA) that can be found at:

https://h30670.www3.hp.com/ecommerce/common/disclaimer.do#EN\_US as modified by the following:

"7. Term.

Unless otherwise terminated earlier pursuant to the terms contained in this EULA, the license for the HP Pro Security Edition (HP Sure Sense Pro and HP Sure Click Pro) is effective upon activation and will continue for thirty-six (36) months thereafter ("Initial Term"). At the end of the Initial Term you may either (a) purchase a renewal license for the HP Pro Security Edition from HP.com, HP Sales or an HP Channel Partner, or (b) continue using the standard versions of HP Sure Click and HP Sure Sense at no additional cost with no future software updates or HP Support."

versions of HP Sure Click and HP Sure Sense at no additional cost with no future software updates or HP Support."
HP Pro Security Edition is optimized for the SMB environment and ships pre-configured - manageability is optional. The HP Pro Security Edition supports a limited tool set that can be used by the HP Manageability Integration Kit which can be downloaded from http://www.hp.com/go/clientmanagement.

34. HP Fingerprint sensor is an optional feature that must be configured at purchase.



### **Technical Specifications**

#### **POWER**

#### **Power Supply**

HP Smart 65 W External AC power adapter <sup>35</sup> HP Smart 65 W EM External AC power adapter <sup>35</sup> HP Smart 65 W USB Type-C adapter <sup>35</sup> HP Smart 45 W External AC power adapter <sup>35</sup> HP Smart 45 W USB Type-C adapter <sup>35</sup>

#### **Power Cord**

3-wire plug - 1m <sup>35</sup> 2-wire plug - 1m <sup>35</sup>

#### **Primary Battery**

HP Long Life 3-cell, 45 Wh Li-ion polymer <sup>36,37</sup> Support HP Fast Charge (Up to 50% in 30 minutes with 65W AC Adapter)<sup>38</sup>

#### **Battery life**

Up to 17 hours 39

- 35. Availability may vary by country.
- 36. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 37. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.
- 38. Supports HP Fast Charge with 65W AC Adapter. Recharges the battery up to 50% within 30 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 watts is required. After charging has reached 50% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.
- 39. Windows 10 MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

#### **WEIGHTS & DIMENSIONS**

#### Weight

Starting at 3.19 lb (1.45 kg)40

#### Dimensions (w x d x h)

12.15 x 8.78 x 0.71 in 30.85 x 22.295 x 1.795 cm

40. Weight will vary by configuration.



### **Technical Specifications**

#### **PORTS/SLOTS**

#### **Ports**

1 SuperSpeed USB Type-C<sup>®</sup> 10Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4)

2 SuperSpeed USB Type-A 5 Gbps signaling rate (1 charging port)

1 HDMI 1.4h41

1 Headphone/microphone combo jack

1 AC power

#### **Expansion Slots**

1 microSD Supports SD, SDHC, SDXC

41. HDMI cable sold separately.

#### **SERVICE AND SUPPORT**

1-year and 3-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for HP Long Life batteries which will follow the one or three year warranty of the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc. 42

42. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



**Planned Industry Standard** 

Certifications

### **Technical Specifications**

#### **SYSTEM UNIT**

 $\textbf{Stand-Alone Power} \qquad \qquad \textbf{Nominal Operating} \qquad \qquad 19 \ \text{V}$ 

Requirements (AC Power) Voltage

**Average Operating Power** 5.71 w **Integrated Graphics** AMD

Max Operating Power UMA < 45W

**Temperature Operating** 41° to 95° F (5° to 35° C)

**Non-operating** -4° to 140° F (-20° to 60° C)

Relative Humidity Operating 10% to 90%, non-condensing

**Non-operating** 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Shock Operating 40 G, 2 ms, half-sine

**Non-operating** 200 G, 2 ms, half-sine

**Random Vibration Operating** 0.75 grms

Non-operating 1.50 grms

Altitude (unpressurized) Operating -50 to 10,000 ft (-15.24 to 3,048 m)

**Non-operating** -50 to 10,000 ft (-15.24 to 3,048 m)

UL Yes
CSA Yes
FCC Compliance Yes

**ENERGY STAR**° Yes, Select models<sup>43</sup> **EPEAT**® Yes, Gold in U.S.<sup>44</sup>

**ICES** Yes **Australia** Yes **NZ A-Tick Compliance** Yes CCC Yes **Japan VCCI Compliance** Yes KC Yes **BSMI** Yes **CE Marking Compliance** Yes **BNCI or BELUS** Yes CIT Yes **EAC** Yes Saudi Arabian Compliance Yes (ICCP)

SABS Yes UKRSERTCOMPUTER Yes

43. Configurations of the HP ProBook x360 435 G7 G8 that are ENERGY STAR® qualified are identified as HP ProBook x360 435 G8 ENERGY STAR on HP websites and on http://www.energystar.gov.

44. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit www.epeat.net for more information.



## **Technical Specifications**

#### **DISPLAYS**

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

1. Actual brightness will be lower with touchscreen or Sure View.

Panel LCD 13.3 inch diagonal FHD (1920 x 1080) Anti-Glare WLED UWVA 45% NTSC 250 nits eDP 1.2 w/o PSR slim Outline Dimensions (W x H x D) 300.56 x 187.77 mm (max) (w/ PCB & w/o bracket)

**Active Area** 293.76 x 165.24 mm (typ.)

Weight 260 g (max)

Diagonal Size 13.3 inch

Thickness 3.0 mm (max)
Interface eDP 1.2 (2 lane)

Surface Treatment BrightView Glass

**Touch Enabled** Yes

Contrast Ratio 600:1 (typ.)

Refresh Rate 60 Hz

**Brightness**<sup>1</sup> 250nits (typ.)

Pixel Resolution 1920 x 1080 (FHD)

Format of LCD Pixel Arrangement RGB

Backlight LED

**Color Gamut Coverage** 45% NTSC

**Color Depth** 6 bits

Viewing Angle UWVA 85/85/85



### **Technical Specifications**

Panel LCD 13.3 inch diagonal FHD (1920 x 1080) Anti-Glare WLED UWVA 72% NTSC 400 nits eDP 1.4+PSR2 ultraslim Outline Dimensions (W x H x D) 299.06 x 185.54 mm (max)

**Active Area** 293.76 x 165.24 mm (typ.)

Weight 170 g (max)

Diagonal Size 13 inch

Thickness 2.0 mm (max)

**Interface** eDP 1.4 + PSR2 (2 lane)

**Surface Treatment** BrightView Glass

**Touch Enabled** Yes

Contrast Ratio 1200:1 (typ.)

Refresh Rate 60 Hz
Brightness¹ 400 nits

Pixel Resolution 1920 x 1080 (FHD)

Format of LCD Pixel Arrangement RGB

Backlight LED

**Color Gamut Coverage** 72% NTSC

**Color Depth** 8 bits

Viewing Angle UWVA 85/85/85



### **Technical Specifications**

Panel LCD 13.3 inch diagonal FHD (1920 x 1080) BrightView WLED UWVA 72% NTSC 1000 nits eDP 1.4+PSR2 flat Privacy NWBZ

**Outline Dimensions (W x H x D)** 298.76 x 186.04 mm (typ.)

**Active Area** 293.76 x 165.24 mm (typ.)

Weight 255 g (max)

Diagonal Size 13.3 inch

Thickness 3.0 mm (max)

Interface eDP 1.4 + PSR2

Surface Treatment BrightView Glass

**Touch Enabled** Yes

Contrast Ratio 2000:1 (typ.)

**Refresh Rate** 60 Hz

**Brightness<sup>1</sup>** 1000 nits

Pixel Resolution 1920 x 1080(FHD)

Format of LCD Pixel Arrangement RGB

Backlight LED

**Color Gamut Coverage** 72% NTSC

Color Depth 8 bit

Viewing Angle UWVA 85/85/85



## **Technical Specifications**

#### **STORAGE**

Note: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

128 GB 2280 M2 PCIe NVMe TLC Solid State Drive Form Factor M.2 2280
Capacity 128 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe

Maximum Sequential Read1300~2047MB/sMaximum Sequential Write800~1200MB/sLogical Blocks250,069,680

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp] **Features** ATA Security; DIPM; TRIM; DEVSLP

256 GB 2280 PCIe NVMe Value Solid State Drive Form Factor M.2 2280
Capacity 256 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe

Maximum Sequential Read Around 1500 ~ 1700 MB/s

Maximum Sequential Write Around 780 ~ 1300 MB/s

**Logical Blocks** 500118192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** ATA Security; TRIM; L1.2



## **Technical Specifications**

SSD 512 GB 2280 M2 PCIe-3x4 SS NVMe TLC Form Factor M.2 2280
Capacity 512 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3X4

Maximum Sequential Read Around 2700 ~ 3400 MB/s
Maximum Sequential Write Around 1390 ~ 2956 MB/s

**Logical Blocks** 1000215215

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** ATA Security; TRIM; L1.2

SSD 512 GB 2280 PCIe NVMe Value Form Factor M.2 2280
Capacity 512 GB
NAND Type TLC/QLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe

Maximum Sequential Read Around 1500 ~ 1700 MB/s

Maximum Sequential Write Around 860 ~ 1500 MB/s

**Logical Blocks** 1000215215

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; TRIM; L1.2



## **Technical Specifications**

SSD 1TB 2280 PCIe-3x4 NVMe Form Factor Three Layer Cell single-sided

Form Factor M.2 2280
Capacity 1 TB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

InterfacePCIe NVMe Gen3X4Maximum Sequential Read3100 ~ 3500 MB/sMaximum Sequential Write2770 ~ 3037 MB/sLogical Blocks2000409264

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** ATA Security; TRIM; L1.2



### **Technical Specifications**

#### **NETWORKING/COMMUNICATIONS**

Realtek RTL8822CE 802.11ac 2x2 Wi-Fi® and Bluetooth® 5.01 Wireless LAN Standards IEEE 802.11a

IEEE 802.11b

IEEE 802.11n
IEEE 802.11ac
IEEE 802.11d
IEEE 802.11e
IEEE 802.11h
IEEE 802.11i
IEEE 802.11k
IEEE 802.11r
IEEE 802.11v

**Interoperability** Wi-Fi certified

•802.11b/g/n 2.402 – 2.482 GHz

•802.11a/n/ac

4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz

**Data Rates** •802.11b: 1, 2, 5.5, 11 Mbps

•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

•802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz & 80MHz)

**Modulation** Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security<sup>3</sup> •IEEE 64 / 128 bit WEP encryption for a/b/g mode only

•AES-CCMP: 128 bit in hardware

•802.1x authentication

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certificationWPA3 certificationIEEE 802.11iWAPI

**Network Architecture** 

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

**Roaming** IEEE 802.11 compliant roaming between access points

Output Power<sup>2</sup> • 802.11b: +18.5dBm minimum

• 802.11g: +17.5dBm minimum • 802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
802.11n HT40(2.4GHz): +14.5dBm minimum
802.11n HT20(5GHz): +15.5dBm minimum

### **Technical Specifications**

802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum

• 802.11ac VHT160(5GHz): +11.5dBm minimum

**Power Consumption** •Transmit mode: 2.0 W

•Receive mode: 1.6 W

Idle mode (PSP)180 mW (WLAN Associated)
 Idle mode: 50 mW (WLAN unassociated)
 Connected Standby/Modern Standby: 10mW

•Radio disabled: 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity<sup>4</sup>** 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac. MCS9: -59dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard with CNVi Interface

**Dimensions** 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

**Weight** 1. Type 2230: 2.8 g

2. Type 126: 1.3 g

Operating Voltage 3.3 v +/- 9%

**Temperature Operating** 14° to 158° F (–10° to 70° C)

**Non-operating**  $-40^{\circ}$  to  $176^{\circ}$  F ( $-40^{\circ}$  to  $80^{\circ}$  C)

**Humidity Operating** 10% to 90% (non-condensing)

**Non-operating** 5% to 95% (non-condensing)

**Altitude Operating** 0 to 10,000 ft (3,048 m)

**Non-operating** 0 to 50,000 ft (15,240 m)

**LED Activity** LED Amber – Radio OFF

LED OFF - Radio ON

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Technology

**Bluetooth Specification** 4.0/4.1/4.2/5.0 Compliant

Frequency Band 2402 to 2480 MHz

**Number of Available** Legacy: 0~79 (1 MHz/CH) **Channels** BLE: 0~39 (2 MHz/CH)



### **Technical Specifications**

Signaling Data Rate Legacy: 3 Mbps signaling data rate<sup>1</sup> 2.17 Mbps

BLE: 1 Mbps signaling data rate<sup>1</sup> 0.2 Mbps

1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

**Power Consumption** Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

**Bluetooth Software** 

Supported

Microsoft Windows Bluetooth Software

**Power Management** Microsoft Windows ACPI, and USB Bus Support

Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

**Power Management** 

ETS 300 328, ETS 300 826 Certifications Low Voltage Directive IEC950

UL, CSA, and CE Mark

**Bluetooth Profiles** Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode

LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)



<sup>1.</sup> Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.

<sup>2.</sup> The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

<sup>3.</sup> Check latest software/driver release for updates on supported security features.

<sup>4.</sup> Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/q (OFDM modulation).

### **Technical Specifications**

Intel® Wi-Fi 6 AX200 and Wireless LAN Standards

Bluetooth® 5.0 (802.11ax 2 x 2, supporting gigabit data rate) non-vPro<sup>1,5</sup> IEEE 802.11a

IEEE 802.11b

IEEE 802.11n

IEEE 802.11ac IEEE 802.11ax IEEE 802.11d

IEEE 802.11e IEEE 802.11h

IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v

Interoperability

Wi-Fi certified

Frequency Band •802.11b/g/n/ax

2.402 – 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz

5.47 – 5.725 GHz 5.825 – 5.850 GHz

**Data Rates** •802.11b: 1, 2, 5.5, 11 Mbps

•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

•802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

**Modulation** Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security<sup>3</sup> •IEEE 64 / 128 bit WEP encryption for a/b/g mode only

•AES-CCMP: 128 bit in hardware

•802.1x authentication

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

•WPA2 certification •IEEE 802.11i

•WAPI

Network Architecture Ad-hoc (Peer to Peer)

Models

Infrastructure (Access Point Required)

**Roaming** IEEE 802.11 compliant roaming between access points

Output Power<sup>2</sup> • 802.11b: +18.5dBm minimum

• 802.11g: +17.5dBm minimum • 802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
 802.11n HT40(2.4GHz): +14.5dBm minimum

### **Technical Specifications**

• 802.11n HT20(5GHz): +15.5dBm minimum

• 802.11n HT40(5GHz): +14.5dBm minimum

• 802.11ac VHT80(5GHz): +11.5dBm minimum

• 802.11ac VHT160(5GHz): +11.5dBm minimum

• 802.11ax HT40(2.4GHz): +10dBm minimum

• 802.11ax VHT160(5GHz): +10dBm minimum

Power Consumption • Transmit mode: 2.0 W

•Receive mode: 1.6 W

Idle mode (PSP)180 mW (WLAN Associated)
 Idle mode: 50 mW (WLAN unassociated)
 Connected Standby/Modern Standby: 10mW

•Radio disabled: 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity<sup>4</sup>** 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac. MCS9: -59dBm maximum

802.11ax, MCS11(HT40): -59dBm maximum 802.11ax, MCS11(VHT160): -58.5dBm maximum

**Antenna type** High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

**Weight** 1. Type 2230: 2.8 g

2. Type 126: 1.3 g

Operating Voltage 3.3 v +/- 9%

**Temperature Operating** 14° to 158° F (-10° to 70° C)

**Non-operating**  $-40^{\circ}$  to  $176^{\circ}$  F ( $-40^{\circ}$  to  $80^{\circ}$  C)

**Humidity Operating** 10% to 90% (non-condensing)

**Non-operating** 5% to 95% (non-condensing)

**Altitude Operating** 0 to 10,000 ft (3,048 m)

**Non-operating** 0 to 50,000 ft (15,240 m)

**LED Activity** LED Amber – Radio OFF

LED OFF - Radio ON



### **Technical Specifications**

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology

**Bluetooth Specification** 4.0/4.1/4.2/5.0/5.1 Compliant

Frequency Band 2402 to 2480 MHz

**Number of Available** Legacy: 0~79 (1 MHz/CH) **Channels** BLE: 0~39 (2 MHz/CH)

**Signaling Data Rate** Legacy: 3 Mbps signaling data rate<sup>1</sup> 2.17 Mbps

BLE: 1 Mbps signaling data rate<sup>1</sup> 0.2 Mbps

1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 9.5 dBm for BR and EDR.

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

**Bluetooth Software** 

Supported

Microsoft Windows Bluetooth Software

**Power Management** Microsoft Windows ACPI, and USB Bus Support

Certifications

FCC (47 CFR) Part 15C, Section 15.247 & 15.249

**Power Management** 

Certifications

ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

**Bluetooth Profiles** 

Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping

LE Dual Mode LE Link Laver

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)



### **Technical Specifications**

1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax

devices. Only available in countries where 802.11ax is supported.

- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
- 5. Wi-Fi 5 or 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

Intel® 9260 802.11a/b/g/n/ac (2 x 2) Wi-Fi® and Bluetooth® 5 Combo¹ (Non-vPro)	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g
		IEEE 802.11n
		IEEE 902 11d

IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v Wi-Fi certified

Interoperability Wi-Fi certified
Frequency Band •802.11b/g/n

2.402 – 2.482 GHz •802.11a/n/ac 4.9 – 4.95 GHz (Japan)

5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz

**Data Rates** •802.11b: 1, 2, 5.5, 11 Mbps

•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

•802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

**Modulation** Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security<sup>3</sup> •IEEE 64 / 128 bit WEP encryption for a/b/g mode only

•AES-CCMP: 128 bit in hardware

•802.1x authentication



### **Technical Specifications**

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

•WPA2 certification •WPA3 certification •IEEE 802.11i

•WAPI

**Network Architecture** 

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

**Roaming** IEEE 802.11 compliant roaming between access points

**Output Power<sup>2</sup>** • 802.11b: +18.5dBm minimum

802.11g: +17.5dBm minimum802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
802.11n HT40(2.4GHz): +14.5dBm minimum
802.11n HT20(5GHz): +15.5dBm minimum
802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum
802.11ac VHT160(5GHz): +11.5dBm minimum

**Power Consumption** •Transmit mode: 2.0 W

•Receive mode: 1.6 W

Idle mode (PSP)180 mW (WLAN Associated)
 Idle mode: 50 mW (WLAN unassociated)
 Connected Standby/Modern Standby: 10mW

•Radio disabled: 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity**<sup>4</sup> 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

**Form Factor** PCI-Express M.2 MiniCard

**Dimensions** 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

**Weight** 1. Type 2230: 2.8 g

2. Type 126: 1.3 g

Operating Voltage 3.3 v +/- 9%

**Temperature Operating** 14° to 158° F (-10° to 70° C)

**Non-operating**  $-40^{\circ}$  to  $176^{\circ}$  F ( $-40^{\circ}$  to  $80^{\circ}$  C)

### **Technical Specifications**

**Humidity** Operating 10% to 90% (non-condensing)

**Non-operating** 5% to 95% (non-condensing)

 Altitude
 Operating
 0 to 10,000 ft (3,048 m)

 Non-operating
 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF

LED OFF - Radio ON

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Technology

**Bluetooth Specification** 4.0/4.1/4.2/5.0 Compliant

Frequency Band 2402 to 2480 MHz

**Number of Available** Legacy: 0~79 (1 MHz/CH) **Channels** BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps signaling data rate<sup>1</sup> 2.17 Mbps

BLE: 1 Mbps signaling data rate<sup>1</sup> 0.2 Mbps

1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

**Power Consumption** Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Bluetooth Software

Supported

Microsoft Windows Bluetooth Software

**Power Management** Microsoft Windows ACPI, and USB Bus Support

Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management

Certifications

ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

**Bluetooth Profiles** 

Supported

BT4.1-ESR 5/6/7 Compliance

**LE Link Layer Ping** 

LE Dual Mode

LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

### **Technical Specifications**

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

- 1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.
- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

#### **POWER**

HP 45 W USB type C	
Straight 1.8 m AC	
Adapter	

**Dimensions** 94.0 mm x 40.0 mm x 26.5 mm

Weight 192.5 q +/- 10 q

(Not including power cord. Power cord varies by country)

Input **Input Efficiency** Average Efficiency of 25%, 50%, 75%, 100%

load condition with 115Vac/230Vac Spec:

5V: 81.5% 9V: 86.7% 12V: 87.41% 15V: 87.8%

Input frequency range 47 ~ 63 Hz

**Input AC current** Max. 1.4 A at 90 VAC

5V/15W Output **Output power** 

> 9V/27W 12V/36W 15V/45W

**DC** output 5V / 9V / 12V / 15V Hold-up time 5ms at 115 Vac input

< 5.0A **Output current limit** 

Connector USB Type-C™

**Environmental Design** Operating temperature 32° to 95° F (0° to 35° C)

Non-operating (storage) -4° to 185° F (-20° to 85° C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% 10% to 95% **Storage Humidity** 

**EMI and Safety** CE Mark - full compliance with LVD and EMC directives Certifications

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1,

SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B.

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.

### **Technical Specifications**

HP 45 W Smart AC adapter

**Dimensions** 3.74 x 1.57 x 1.04 in (9.5 x 4.0 x 2.65 cm)

**Weight** 0.386 lb (175g) max

(Not including power cord. Power cord varies by country)

Input 90 to 265 VAC

**Input Efficiency** 87.74% at 115Vac and 88.4% at 230Vac

Input frequency range 47 ~ 63 Hz

**Input AC current** 1.4 A at 90 VAC

**Output Output power** 45 W

**DC output** 19.5 V

**Hold-up time** 5ms at 115 Vac input

Output current limit <8.0A

**Connector** 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords

Environmental Design Operating temperature  $32^{\circ}$  to  $95^{\circ}$  F ( $0^{\circ}$  to  $35^{\circ}$  C) Non-operating (storage)  $-4^{\circ}$  to  $185^{\circ}$  F ( $-20^{\circ}$  to  $85^{\circ}$  C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 45 Watt Smart nPFC Standard Barrel 4.5 mm Right Angle 1.8 m 2prong **Dimensions** 95.0 x 40.0 x 26.5 mm

**Weight**  $200 \, q + / - 10 \, q$ 

(Not including power cord. Power cord varies by country)

Input Input Efficiency 87.74% at 115Vac and 88.4% at 230Vac

Input frequency range 47 ~ 63 Hz
Input AC current 1.4 A at 90 VAC

Output Output power 45 W

**DC output** 19.5 V

**Hold-up time** 5ms at 115 Vac input

Output current limit <8.0A

**Connector** C6

**Environmental Design** Operating temperature 32° to 95° F (0° to 35° C)

Non-operating (storage) -4° to 185° F (-20° to 85° C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

**EMI and Safety** CE Mark - full compliance with LVD and EMC directives

Certifications Worldwide safety standards - IEC60950, EN60950, UL60950, Class 1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

MTBF - over 200,000 hours at 25°C ambient condition.

### **Technical Specifications**

AC Adapter 65 Watt nPFC Dimensions Standard USB Type-C Weight Straight 1.8 m

**Dimensions** 90.0 x 51 x 28.5 mm **Weight** 250 q +/- 10 q

(Not including power cord. Power cord varies by country)

Input Input Efficiency 81.5% min at 115 Vac/ 230Vac @ 5V/3A

86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A

**Input frequency range** 47 ~ 63 Hz

**Input AC current** 1.6 A at 90 VAC and maximum load

Output Output power 65 W

DC output 5V/9V/12V/15V/20V
Hold-up time 5ms at 115 Vac input
Output current limit <8.0A MAXIMUM

**Connector** USB Type-C™

Environmental Design Operating temperature 32° to 95° F (0° to 35° C)

Non-operating (storage) -4° to 185° F (-20° to 85° C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

Humidity20% to 95%Storage Humidity10% to 95%

**EMI and Safety**CE Mark - full compliance with LVD and EMC directives
Worldwide safety standards -IEC60950, EN60950, UL6

Worldwide safety standards -IEC60950, EN60950, UL60950, UL62368, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022

Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.



### **Technical Specifications**

AC Adapter 65 Watt Smart nPFC EM Barrel 4.5 mm New EM 
 Dimensions
 102 x 55 x 30 mm

 Weight
 250 q +/- 10 q

(Not including power cord. Power cord varies by country)

**Input Input Efficiency** 88.0 % at 115 Vac and 89.0 % at 230Vac

Input frequency range 47 ~ 63 Hz
Input AC current 1.7 A at 90 Vac

**Output Output power** 65 W

**DC output** 19.5 V

**Hold-up time** 5ms at 115 Vac input

Output current limit <11.0 A

**Connector** C6

**Environmental Design** Operating temperature 32° to 95° F (0° to 35° C)

Non-operating (storage) -4° to 185° F (-20° to 85° C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards -IEC60950, EN60950, UL60950, UL62368, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022

Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 65 Watt Smart nPFC Standard Barrel 4.5 mm Right Angle 1.8 m **Dimensions** 90.0 x 51 x 28.5 mm **Weight** 230 q +/- 10 q

(Not including power cord. Power cord varies by country)

**Input Input Efficiency** 88.0 % at 115 Vac and 89.0 % at 230 Vac

Input frequency range 47 ~ 63 Hz Input AC current 1.7 A at 90 Vac

 Output
 Output power
 65 W

 DC output
 19.5 V

**Hold-up time** 5ms at 115 Vac input

Output current limit <11.0 A

Connector 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords

**Environmental Design** Operating temperature 32° to 95° F (0° to 35° C)

Non-operating (storage) -4° to 185° F (-20° to 85° C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety CE Mark - full compliance with LVD and EMC directives Certifications Worldwide safety standards - IEC60950, EN60950, UL6

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.

### **Technical Specifications**

**Battery SX 3 Cell** 45 Wh Long Life -PL **Fast Charge** 

**Dimensions** (H x W x L) 184.62 x 85.25 x 6.15 mm

Weight 0.195 kg Max

Cells/Type 3cell Lithium-Ion Polymer cell

Energy Voltage 13.2V / 11.55V (13.2V / 11.4V)

> Amp-hour capacity 3.9 Ah / 3.75 Ah (3.95 Ah / 3.79 Ah)

**Watt-hour capacity** 45 Wh

32° to 113° F (0° to 45° C) Operating (Charging) **Temperature Operating (Discharging)** 14° to 122° F (-10° to 60° C)

**Optional Travel Battery** 

No **Available** 

Based on system offering Warranty



## Technical Specifications

### **COUNTRY OF ORIGIN**

China



## Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part #
Cases	HP Essential Top Load Case	H2W17AA
	HP Essential Backpack (up to 15.6")	H1D24AA
Docking	HP USB-C Mini Dock	1PM64AA
	HP Thunderbolt Dock 120W G2	2UK37AA
	HP TB Dock G2 w/ Combo Cable	3TR87AA
	HP TB Dock 120W G2 w/Audio	3YE87AA
	HP TB Dock 120W G2 cable	3XB94AA
	HP TB Dock G2 combo cable	3XB96AA
	HP TB Dock 120W G2 Cable	3XB94AA
	HP TB Dock G2 Combo Cable	3XB96AA
	HP TB Dock G2 Audio Module	3AQ21AA
	HP USB-C/A Universal Dock G2	5TW13AA
	HP USB-C Dock G5	5TW10AA
Input/Output	HP Comfort Grip Wireless Mouse	H2L63AA
	HP 3-Button USB Laser Mouse	H4B81AA
	HP USB Travel Mouse	G1K28AA
	HP USB-C to RJ45 Adapter	V7W66AA
	HP Ultra Mobile Wireless Mouse	H6F25AA
	HP USB Fingerprint Mouse	4TS44AA
	HP USB-C to DP	N9K78AA
	HP USB-C to USB-A Hub	Z6A00AA
	HP Elite USB-C Multi Port Hub	4WX89AA
	HP Pro Pen	8JU62AA
Power	HP 45W Smart AC Adapter 4.5mm	H6Y88AA
	HP 65W Smart AC Adapter 4.5mm	H6Y89AA
	HP 45W LC USB-C Power Adapter	1MZ01AA
	HP 65W LC USB-C Power Adapter	TBD
	USB-C NB Power Bank	1TZ86AA
	HP Essential Power Bank	3TB55AA
Storage	HP External USB Optical Drive	F2B56AA
Security	HP Sure Key Cable Lock	6UW42AA
	HP Nano Keyed Cable Lock	1AJ39AA

Date of change:	Version History:	Description of change:
	V1 to V2	



### **Summary of Changes**

Copyright © 2021 HP Development Company, L.P. The information contained herein is subject to change without notice. The only warranties for HP products are set forth in the express limited warranty statements accompanying such products. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein.

AMD and Radeon are trademarks of Advanced Micro Devices, Inc. Bluetooth is a trademark owned by its proprietor and used by HP Inc. under license. DisplayPort™ and the DisplayPort™ logo are trademarks owned by the Video Electronics Standards Association (VESA®) in the United States and other countries. USB Type-C® and USB-C® are registered trademarks of USB Implementers Forum. SDXC is a registered trademark of SD-3C in the United States, other countries or both. ENERGY STAR is a registered trademark of the U.S. Environmental Protection Agency. All other trademarks are the property of their respective owners.

